



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Serial No.: 09/831,763

Filed: May 11, 2001  
Inventor(s): Heinrich Meyer et al.  
For: Method of Galvanically  
Forming Conductor  
Structures of High-Purity  
Copper in the Production  
of Integrated Circuits  
Examiner: Mutschler, Brian L.  
Art Unit: 1753

Attorney Docket No.: 071-01

---

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**CERTIFICATE OF MAILING**

DATE OF DEPOSIT: November 24, 2003

I hereby certify that this correspondence is being  
deposited with the United States Postal Service,  
postage paid, as first class mail under 37 C.F.R. §1.8,  
on the date indicated above and is addressed to  
Commissioner for Patents, P.O. Box 1450,  
Alexandria, VA 22313-1450.

Name of person  
mailing paper or fee: Ourmazd S. Ojan

Signature: O - m a z d S . O j a n

**AMENDMENT**

Dear Sir:

This communication is responsive to the Office Action mailed on June 23, 2003, and  
having a three-month shortened statutory period for response that expired on September 23, 2003.  
Attached hereto is a petition for a two-month extension of time and a check in the amount of  
\$420.00 for the extension fee. Accordingly, the period for response to the Office action is extended  
to Monday November 24, 2003, in view of the fact that November 23, 2003 falls on a Sunday. This  
amendment is being filed within the extended period for response and therefore no additional  
extension fees are believed to be due at this time.

In the event that any additional fees are required with respect to this communication, the Commissioner is hereby authorized to charge any such fees, or credit any overpayment, to Paul & Paul deposit account number 16-0750.

Please amend the application as follows: